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**Part 1**

**Special Issue on Trends in Electronics Education (2)**

**Guest Editors**

**Ahmad Ibrahim and Aleksander Malinowski**

**Part 2**

**Contributions on Communication Skills, Innovation and  
Creativity, Software Engineering, Engineering Management,  
Control Engineering and Chemical Engineering**

# The International Journal of ENGINEERING EDUCATION

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Tel: (International) +353 27 61400; Fax: (+353 1) 4023999; E-Mail: ijee@eircom.net  
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**Todd, Magleby**—Evaluation and Rewards for Faculty Involved in Engineering Design Education

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**Xu**—Computer-Aided Concurrent Environment for Manufacturing Education

**Liu, Landers**—Integrated Modular Machine Tool Simulation for Education in Manufacturing Automation

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**Liu, Schonwetter**—Teaching Creativity in Engineering

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